

FEATURES

Ideal for RGB/HD/SD video Supports 1080i/720p resolution High speed -3 dB bandwidth: 300 MHz Slew rate: 750 V/µs Settling time: 9 ns (0.5%) 0.1 dB flatness: 65 MHz Differential gain: 0.02% Differential phase: 0.03° Wide supply range: 5 V to 12 V Low power: 5.3 mA/amp Low voltage offset (RTO): 3.5 mV (typ) High output current: 25 mA Also configurable for gains of +1, -1 Power-down

APPLICATIONS

Consumer video Professional video Filter buffers

GENERAL DESCRIPTION

The ADA4862-3 (triple) is a low cost, high speed, internally fixed, G = +2 op amp, which provides excellent overall performance for high definition and RGB video applications. The 300 MHz, G = +2, -3 dB bandwidth, and 750 V/µs slew rate make this amplifier well suited for many high speed applications. The ADA4862-3 can also be configured to operate in gains of G = +1 and G = -1.

With its combination of low price, excellent differential gain (0.02%), differential phase (0.03°), and 0.1 dB flatness out to 65 MHz, this amplifier is ideal for both consumer and professional video applications.

The ADA4862-3 is designed to operate on supply voltages as low as +5 V and up to ± 5 V using only 5.3 mA/amp of supply current. To further reduce power consumption, each amplifier is equipped with a power-down feature that lowers the supply current to 200 μ A/amp. The ADA4862-3 also consumes less board area because feedback and gain set resistors are on-chip. Having the resistors on chip simplifies layout and minimizes the required board space.

Rev. A

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

High Speed, G = +2, Low Cost, Triple Op Amp ADA4862-3

PIN CONFIGURATION



The ADA4862-3 is available in a 14-lead SOIC package and is designed to work in the extended temperature range of -40° C to $+105^{\circ}$ C.



Figure 2. Large Signal 0.1 dB Bandwidth for Various Supplies

 One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.

 Tel: 781.329.4700
 www.analog.com

 Fax: 781.461.3113
 © 2005 Analog Devices, Inc. All rights reserved.

ADA4862-3* Product Page Quick Links

Last Content Update: 10/05/2016

Comparable Parts

View a parametric search of comparable parts

Evaluation Kits

• ADA4862-3 Evaluation Board

Documentation 🖵

Data Sheet

• ADA4862-3: High Speed, G= +2, Low Cost, Triple Op Amp Data Sheet

Product Highlight

· Amplifier pricing where you want it,

User Guides

• UG-114: Universal Evaluation Board for Triple, High Speed Op Amps Offered in 14-Lead SOIC Packages

Reference Materials

Informational

• Advantiv[™] Advanced TV Solutions

Product Selection Guide

- · Amplifiers for Video Distribution
- High Speed Amplifiers Selection Table

Tutorials

- MT-034: Current Feedback (CFB) Op Amps
- MT-051: Current Feedback Op Amp Noise Considerations
- MT-057: High Speed Current Feedback Op Amps
- MT-059: Compensating for the Effects of Input Capacitance on VFB and CFB Op Amps Used in Current-to-Voltage Converters

Design Resources 🖵

- ADA4862-3 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

Discussions 🖵

View all ADA4862-3 EngineerZone Discussions

Sample and Buy

Visit the product page to see pricing options

Technical Support

Submit a technical question or find your regional support number

^{*} This page was dynamically generated by Analog Devices, Inc. and inserted into this data sheet. Note: Dynamic changes to the content on this page does not constitute a change to the revision number of the product data sheet. This content may be frequently modified.

TABLE OF CONTENTS

Features	1
Applications	1
Pin Configuration	1
General Description	1
Revision History	2
Specifications	3
Absolute Maximum Ratings	5
Thermal Resistance	5
ESD Caution	5
Typical Performance Characteristics	6

REVISION HISTORY

8/05—Rev. 0 to Rev. A	
Changes to Ordering Guide	. 15

7/05—Revision 0: Initial Version

Applications11
Using the ADA4862-3 in Gains = +1, -1 11
Video Line Driver
Single-Supply Operation13
Power Down
Layout Considerations14
Power Supply Bypassing14
Dutline Dimensions
Ordering Guide

SPECIFICATIONS

 V_{S} = +5 V (@T_{\text{A}} = 25°C, G = +2, R_{\text{L}} = 150 $\Omega,$ unless otherwise noted).

Table 1.

Parameter	Conditions	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE					
-3 dB Bandwidth	$V_0 = 0.2 V p-p$		300		MHz
	$V_0 = 2 V p - p$		200		MHz
G = +1	$V_0 = 0.2 V p - p$		620		MHz
Bandwidth for 0.1 dB Flatness	$V_0 = 2 V p - p$		65		MHz
+Slew Rate (Rising Edge)	$V_0 = 2 V p - p$		750		V/µs
–Slew Rate (Falling Edge)	$V_0 = 2 V p - p$		600		V/µs
Settling Time to 0.5%	$V_0 = 2 V step$		9		ns
DISTORTION/NOISE PERFORMANCE					
Harmonic Distortion HD2	$f_{C} = 1 \text{ MHz}, V_{O} = 2 \text{ V p-p}$		-81		dBc
Harmonic Distortion HD3	$f_{C} = 1 \text{ MHz}, V_{O} = 2 \text{ V p-p}$		-88		dBc
Harmonic Distortion HD2	$f_{c} = 5 \text{ MHz}, V_{0} = 2 \text{ V p-p}$		-68		dBc
Harmonic Distortion HD3	$f_{c} = 5 \text{ MHz}, V_{0} = 2 \text{ V p-p}$		-76		dBc
Voltage Noise (RTO)	f = 100 kHz		10.6		nV/√Hz
Current Noise (RTI)	f = 100 kHz, +IN		1.4		pA/√Hz
Differential Gain			0.02		%
Differential Phase			0.03		Degrees
Crosstalk	Amplifier 1 driven, Amplifier 2 output measured, f = 1 MHz		-75		dB
DC PERFORMANCE					
Offset Voltage (RTO)	Referred to output (RTO)	-25	+3.5	+25	mV
+Input Bias Current		-2.5	-0.6	+1	μΑ
Gain Accuracy		1.9	2	2.1	V/V
INPUT CHARACTERISTICS					
Input Resistance	+IN		13		MΩ
Input Capacitance	+IN		2		pF
Input Common-Mode Voltage Range	G = +1		1 to 4		V
POWER DOWN PIN					
Input Voltage	Enabled		0.6		V
	Power down		1.8		V
Bias Current	Enabled		-3		μΑ
	Power down		115		μΑ
Turn-On Time			3.5		μs
Turn-Off Time			200		ns
OUTPUT CHARACTERISTICS					
Output Overdrive Recovery Time (Rise/Fall)	$V_{IN} = +2.25 \text{ V to } -0.25 \text{ V}$		85/50		ns
Output Voltage Swing	$R_L = 150 \Omega$		1.2 to 3.8		V
Output Voltage Swing	$R_L = 1 \ k\Omega$		1 to 4		V
Short-Circuit Current	Sinking or sourcing		65		mA
POWER SUPPLY					
Operating Range		5		12	V
Total Quiescent Current	Enabled	14	16	18	mA
Quiescent Current /Amplifier	Power down = +Vs		0.2	0.33	mA
Power Supply Rejection Ratio (RTO)					dB
+PSR	$+V_{s} = 2 V \text{ to } 3 V, -V_{s} = -2.5 V$	-52	-55		dB
–PSR	$+V_s = 2.5 V$, $-V_s = -2 V$ to $-3 V$ Power Down pin = $-V_s$	-49	-52		dB

 $V_{\text{S}}=\pm 5$ V (@T_{\text{A}}=+25^{\circ}\text{C}, G = +2, R_{\text{L}}=150 $\Omega,$ unless otherwise noted).

Table 2.

Parameter	Conditions	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE					
–3 dB Bandwidth	$V_0 = 0.2 V p-p$		310		MHz
	V ₀ = 2 V p-p		260		MHz
G = +1	V _o = 0.2 V p-p		720		MHz
Bandwidth for 0.1 dB Flatness	$V_0 = 2 V p - p$		54		MHz
+Slew Rate (Rising Edge)	$V_0 = 2 V p - p$		1050		V/µs
–Slew Rate (Falling Edge)	$V_0 = 2 V p - p$		830		V/µs
Settling Time to 0.5%	$V_0 = 2 V \text{ step}$		9		ns
DISTORTION/NOISE PERFORMANCE					
Harmonic Distortion HD2	$f_{c} = 1 \text{ MHz}, V_{o} = 2 \text{ V p-p}$		-87		dBc
Harmonic Distortion HD3	$f_{c} = 1 \text{ MHz}, V_{o} = 2 \text{ V } p-p$		-100		dBc
Harmonic Distortion HD2	$f_{c} = 5 \text{ MHz}, V_{0} = 2 \text{ V p-p}$		-74		dBc
Harmonic Distortion HD3	$f_{c} = 5 \text{ MHz}, V_{o} = 2 \text{ V p-p}$		-90		dBc
Voltage Noise (RTO)	f = 100 kHz		10.6		nV/√Hz
Current Noise (RTI)	f = 100 kHz, +IN		1.4		pA/√Hz
Differential Gain			0.01		%
Differential Phase			0.02		Degrees
Crosstalk	Amplifier 1 driven, Amplifier 2 output		-75		dB
	measured, $f = 1 MHz$				
DC PERFORMANCE					
Offset Voltage (RTO)		-25	+2	+25	mV
+Input Bias Current		-2.5	-0.6	+1	μΑ
Gain Accuracy		1.9	2	2.1	V/V
INPUT CHARACTERISTICS					
Input Resistance	+IN		14		MΩ
Input Capacitance	+IN		2		pF
Input Common-Mode Voltage Range	G = +1		-3.7 to +3.8		V
POWER DOWN PIN					
Input Voltage	Enabled		-4.4		V
	Power down		-3.2		V
Bias Current	Enabled		-3		μA
	Power down		250		μA
Turn-On Time			3.5		μs
Turn-Off Time			200		ns
OUTPUT CHARACTERISTICS					
Output Overdrive Recovery Time (Rise/Fall)	$V_{IN} = \pm 3.0 V$		85/40		ns
Output Voltage Swing	$R_L = 150 \Omega$		-3.5 to +3.5		v
Output Voltage Swing	$R_L = 1 \ k\Omega$		-3.9 to +3.9		V
Short-Circuit Current	Sinking or sourcing		115		mA
POWER SUPPLY					
Operating Range		5		12	V
Total Quiescent Current	Enabled	14.5	17.9	20.5	mA
Quiescent Current/Amplifier	Power down = +Vs		0.3	0.5	mA
Power Supply Rejection Ratio (RTO)					dB
+PSR	$+V_{s} = 4 V \text{ to } 6 V, -V_{s} = -5 V$	-54	-57		dB
–PSR	$+V_{s} = 5 V, -V_{s} = -4 V to -6 V,$	+50.5	-54		dB
	Power Down pin = $-V_s$				

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	12.6 V
Power Dissipation	See Figure 3
Common-Mode Input Voltage	±Vs
Storage Temperature	–65°C to +125°C
Operating Temperature Range	–40°C to +105°C
Lead Temperature	JEDEC J-STD-20
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, θ_{JA} is specified for device soldered in circuit board for surface-mount packages.

Table 4. Thermal Resistance

Package Type	θ _{JA}	Unit
14-lead SOIC	90	°C/W

Maximum Power Dissipation

The maximum safe power dissipation for the ADA4862-3 is limited by the associated rise in junction temperature (T_J) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit may change the stresses that the package exerts on the die, permanently shifting the parametric performance of the amplifiers. Exceeding a junction temperature of 150°C for an extended period can result in changes in silicon devices, potentially causing degradation or loss of functionality. The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the die due to the amplifier's drive at the output. The quiescent power is the voltage between the supply pins (V_S) × the quiescent current (I_S).

 $P_D = Quiescent Power + (Total Drive Power - Load Power)$

$$P_D = \left(V_S \times I_S\right) + \left(\frac{V_S}{2} \times \frac{V_{OUT}}{R_L}\right) - \frac{V_{OUT}^2}{R_L}$$

RMS output voltages should be considered.

Airflow increases heat dissipation, effectively reducing θ_{JA} . In addition, more metal directly in contact with the package leads and through holes under the device reduces θ_{JA} .

Figure 3 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 14-lead SOIC (90°C/W) on a JEDEC standard 4-layer board. θ_{JA} values are approximations.



Figure 3. Maximum Power Dissipation vs. Temperature for a 4-Layer Board

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



TYPICAL PERFORMANCE CHARACTERISTICS



Figure 4. Small Signal Frequency Response for Various Supplies



Figure 5. Large Signal Frequency Response for Various Supplies



Figure 6. Large Signal 0.1 dB Bandwidth for Various Supplies



Figure 7. Small Signal Transient Response for Various Supplies



Figure 8. Small Signal Transient Response for Various Capacitor Loads



Figure 9. Small Signal Transient Response for Various Capacitor Loads



Figure 10. Large Signal Transient Response for Various Supplies



Figure 11. Large Signal Transient Response for Various Capacitor Loads



Figure 12. Large Signal Transient Response for Various Capacitor Loads



Figure 13. Input Overdrive Recovery



Figure 14. Output Overdrive Recovery



Figure 20. Large Signal Crosstalk





Figure 25. HD2 vs. Frequency vs. Output Voltage









Figure 28. HD3 vs. Frequency vs. Output Voltage

APPLICATIONS USING THE ADA4862-3 IN GAINS = +1, -1

The ADA4862-3 was designed to offer outstanding video performance, simplify applications, and minimize board area.

The ADA4862-3 is a triple amplifier with on-chip feedback and gain set resistors. The gain is fixed internally at G = +2. The inclusion of the on-chip resistors not only simplifies the design of the application but also eliminates six surface-mount resistors, saving valuable board space and lowers assembly costs. A typical schematic is shown in Figure 29.



Figure 29. Noninverting Configuration (G = +2)

While the ADA4862-3 has a fixed gain of G = +2, it can be used in other gain configurations, such as G = -1 and G = +1, which are discussed next.

Unity-Gain Operation (Option 1)

There are two options for obtaining unity gain (G = +1). The first is shown in Figure 30. In this configuration, the –IN input pin is left floating (feedback is provided via the internal 550 Ω), and the input is applied to the noninverting input. The noise gain for this configuration is 1. Frequency performance and transient response are shown in Figure 31 through Figure 33.



Figure 30. Unity Gain of Option 1



Figure 33. Large Signal Transient Response for Various Capacitor Loads

Option 2

Another option exists for running the ADA4862-3 as a unitygain amplifier. In this configuration, the noise gain is 2, see Figure 34. The frequency response and transient response for this configuration closely match the gain of +2 plots because the noise gains are equal. This method does have twice the noise gain of Option 1; however, in applications that do not require low noise, Option 2 offers less peaking and ringing. By tying the inputs together, the net gain of the amplifier becomes 1. Equation 1 shows the transfer characteristic for the schematic shown in Figure 34. Frequency and transient response are shown in Figure 35 and Figure 36.

$$V_O = V_i \left(\frac{-R_F}{R_G}\right) + V_i \left(\frac{R_F + R_G}{R_G}\right)$$
(1)

which simplifies to $V_0 = V_i$.

GAIN (dB)







Figure 36. Small Signals Transient Response of Option 2



Figure 37. Inverting Configuration (G = -1)



Figure 38. Large Signal Transient Response for Various Capacitor Loads

VIDEO LINE DRIVER

The ADA4862-3 was designed to excel in video driver applications. Figure 39 shows a typical schematic for a video driver operating on a bipolar supplies.



In applications that require two video loads be driven simultaneously, the ADA4862-3 can deliver. Figure 40 shows the ADA4862-3 configured with dual video loads. Figure 41 shows the dual video load performance.



Figure 40. Video Driver Schematic for Two Video Loads



Figure 41. Large Signal Frequency Response for Various Supplies, $R_L = 75 \Omega$

SINGLE-SUPPLY OPERATION

The ADA4862-3 can also operate in single-supply applications. Figure 42 shows the schematic for a single 5 V supply video driver. Resistors R2 and R4 establish the midsupply reference. Capacitor C2 is the bypass capacitor for the midsupply reference. Capacitor C1 is the input coupling capacitor, and C6 is the output coupling capacitor. Capacitor C5 prevents constant current from being drawn through the internal gain set resistor. Resistor R3 sets the circuits ac input impedance.

For more information on single-supply operation of op amps, see www.analog.com/library/analogDialogue/archives/35-02/avoiding/.



Figure 42. Single-Supply Video Driver Schematic

POWER DOWN

The ADA4862-3 is equipped with an independent Power Down pin for each amplifier allowing the user to reduce the supply current when an amplifier is inactive. The voltage applied to the $-V_s$ pin is the logic reference, making single-supply applications useful with conventional logic levels. In a typical 5 V singlesupply application, the $-V_s$ pin is connected to analog ground. The amplifiers are powered down when applied logic levels are greater than $-V_s + 1$ V. The amplifiers are enabled whenever the disable pins are left either floating (disconnected) or the applied logic levels are lower than 1 V above $-V_s$.

LAYOUT CONSIDERATIONS

As is the case with all high speed applications, careful attention to printed circuit board layout details prevents associated board parasitics from becoming problematic. Proper RF design technique is mandatory. The PCB should have a ground plane covering all unused portions of the component side of the board to provide a low impedance return path. Removing the ground plane on all layers from the area near the input and output pins reduces stray capacitance. Termination resistors and loads should be located as close as possible to their respective inputs and outputs. Input and output traces should be kept as far apart as possible to minimize coupling (crosstalk) though the board. Adherence to microstrip or stripline design techniques for long signal traces (greater than about 1 inch) is recommended.

POWER SUPPLY BYPASSING

Careful attention must be paid to bypassing the power supply pins of the ADA4862-3. High quality capacitors with low equivalent series resistance (ESR), such as multilayer ceramic capacitors (MLCCs), should be used to minimize supply voltage ripple and power dissipation. A large, usually tantalum, 10 μ F to 47 μ F capacitor located in proximity to the ADA4862-3 is required to provide good decoupling for lower frequency signals. In addition, 0.1 μ F MLCC decoupling capacitors should be located as close to each of the power supply pins as is physically possible, no more than 1/8 inch away. The ground returns should terminate immediately into the ground plane. Locating the bypass capacitor return close to the load return minimizes ground loops and improves performance.

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-AB CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

> Figure 43. 14-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-14) Dimensions shown in millimeters and (inches)

ORDERING GUIDE

Model	Temperature Range	Package Description	Ordering Quantity	Package Option
ADA4862-3YRZ ¹	–40°C to +105°C	14-Lead SOIC_N	1	R-14
ADA4862-3YRZ-RL ¹	–40°C to +105°C	14-Lead SOIC_N	2,500	R-14
ADA4862-3YRZ-RL71	-40°C to +105°C	14-Lead SOIC_N	1,000	R-14

 1 Z = Pb-free part.

NOTES

Rev. A | Page 16 of 16

www.analog.com

© 2005 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners. D05600-0-8/05(A)